

L Number	Hits	Search Text	DB	Time stamp
-	766	laser and (pulse with picosecond)	USPAT; US-PGPUB	2003/03/25 15:52
-	826820	cutting or cut or dice ordiced or dicing	USPAT; US-PGPUB	2003/03/25 15:15
-	63450	438/\$.ccls.	USPAT; US-PGPUB	2003/03/25 15:15
-	6	(laser and (pulse with picosecond)) and (cutting or cut or dice ordiced or dicing) and 438/\$.ccls.	USPAT; US-PGPUB	2003/03/25 15:51
-	2	(laser and (pulse with picosecond)) with (cutting or cut or dice or diced or dicing)	USPAT; US-PGPUB	2003/03/25 15:53
-	224	(laser and (pulse with picosecond)) and (cutting or cut or dice ordiced or dicing)	USPAT; US-PGPUB	2003/03/25 15:56
-	309554	@ad>20010221 or @rlad>20010221	USPAT; US-PGPUB	2003/03/25 15:56
-	182	((laser and (pulse with picosecond)) and (cutting or cut or dice ordiced or dicing)) not (@ad>20010221 or @rlad>20010221)	USPAT; US-PGPUB	2003/03/25 16:04
-	33921	(cutting or cut or dice ordiced or dicing) with (substrate or wafer)	USPAT; US-PGPUB	2003/03/25 16:05
-	15	((laser and (pulse with picosecond)) and (cutting or cut or dice ordiced or dicing)) not (@ad>20010221 or @riad>20010221)) and ((cutting or cut or dice ordiced or dicing) with (substrate or wafer))	USPAT; US-PGPUB	2003/03/25 16:05